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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Bandyopadhyay et al.

Attorney Docket No.:
NOVLP088/NVLS-002882

Application No.: 10/825,888

Examiner: UNASSIGNED

Filed: April 16, 2004

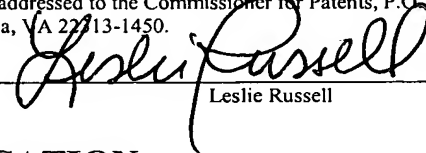
Group: UNASSIGNED

Title: METHOD TO IMPROVE MECHANICAL
STRENGTH OF LOW-K DIELECTRIC FILM
USING MODULATED UV EXPOSURE

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as first-class mail on July 30, 2004 in an envelope addressed to the Commissioner for Patents, P.O. Box 1450 Alexandria, VA 22313-1450.

Signed: _____


Leslie Russell

COMMUNICATION

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Enclosed please find a Supplement Application Data Sheet. This Application Data Sheet is being submitted to update inventor Seon-Mee Cho's mailing address. Please issue an updated Filing Receipt.

Respectfully submitted,
BEYER WEAVER & THOMAS, LLP



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